

# HiPerFET™ **Power MOSFETs Q** Class

N-Channel Enhancement Mode Avalanche Rated High dv/dt, Low Q<sub>a</sub>

Preliminary data sheet

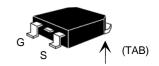
# **IXFH 13N80Q IXFT 13N80Q**

 $\mathbf{V}_{\mathrm{DSS}}$ 800 V 13 A  $0.70 \Omega$ 

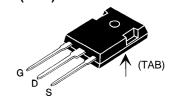
 $t_{rr} \leq$  250 ns



## TO-268 (D3) (IXFT) Case Style



**TO-247 AD (IXFH)** 



G = Gate	D = Drain
S = Source	TAB = Drain

### **Features**

- IXYS advanced low Q<sub>a</sub> process
- International standard packages
- Low R<sub>DS (on)</sub>
   Unclamped Inductive Switching (UIS) rated
- Fast switching
- Molding epoxies meet UL94V-0 flammability classification

### **Advantages**

- Easy to mount
- · Space savings
- · High power density

Symbol	Test Conditions	Maximun	Maximum Ratings		
V <sub>DSS</sub>	T <sub>_1</sub> = 25°C to 150°C	800	V		
V <sub>DGR</sub>	$T_J^{\circ} = 25^{\circ}C$ to 150°C; $R_{GS} = 1 M\Omega$	800	V		
V <sub>GS</sub>	Continuous	±20	V		
V <sub>GSM</sub>	Transient	±30	V		
   <sub>D25</sub>	T <sub>c</sub> = 25°C	13	A		
I <sub>DM</sub>	$T_{\rm C} = 25^{\circ}$ C, pulse width limited by $T_{\rm JM}$	52	Α		
I <sub>AR</sub>	$T_{C} = 25^{\circ}C$	13	Α		
<b>E</b> <sub>AR</sub>	$T_{c} = 25^{\circ}C$	28	mJ		
E <sub>AS</sub>	$T_{c} = 25^{\circ}C$	750	mJ		
dv/dt	$I_{S} \leq I_{DM}$ , di/dt $\leq 100 \text{ A/}\mu\text{s}$ , $V_{DD} \leq V_{DSS}$ ,	5	V/ns		
	$T_J \leq 150^{\circ}C, R_G = 2 \Omega$				
$\overline{\mathbf{P}_{\scriptscriptstyle \mathrm{D}}}$	$T_{c} = 25^{\circ}C$	250	W		
T		-55 +150	°C		
T <sub>JM</sub>		150	°C		
T <sub>stg</sub>		-55 <b>+</b> 150	°C		
T <sub>L</sub>	1.6 mm (0.062 in.) from case for 10 s	300	°C		
$\overline{\mathbf{M}_{d}}$	Mountingtorque	1.13/10	Nm/lb.in.		
Weight	TO-247	6	g		
	TO-268	4	g		

Symbol	Test Conditions	Cł	Characteristic Values			
$(T_J = 25^{\circ}C)$	, unless otherwise specified)		Min.	Тур.	Max	
V <sub>DSS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		800			V
V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 4 \text{ mA}$		2.5		4.5	V
I <sub>GSS</sub>	$V_{GS} = \pm 20 V_{DC}, V_{DS} = 0$				±100	nA
I <sub>DSS</sub>	$V_{DS} = V_{DSS}$	$T_{J} = 25^{\circ}C$			50	μА
	$V_{GS} = 0 \text{ V}$	T <sub>J</sub> = 125°C			1	mA
R <sub>DS(on)</sub>	$V_{GS} = 10 \text{ V}, I_{D} = 0.5 I_{D25}$				0.70	Ω
(-11)	Pulse test, t < 300 us, duty	cvcle d < 2 %				



Symbol		Characteristic Values C, unless otherwise specified)			
		in.	Тур.	Max.	
$g_{fs}$	$V_{DS} = 10 \text{ V}; I_{D} = 0.5 I_{D25}, \text{ pulse test}$	8	13		S
C <sub>iss</sub>	)		3250		pF
$\mathbf{C}_{oss}$	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$		310		pF
$\mathbf{C}_{rss}$	)		60		pF
t <sub>d(on)</sub>	)		23		ns
t <sub>r</sub>	$V_{GS} = 10 \text{ V}, V_{DS} = 0.5 V_{DSS}, I_{D} = 0.5 I_{D25}$		36		ns
$\mathbf{t}_{d(off)}$	$R_{\rm G} = 3.2 \Omega $ (External)		55		ns
t <sub>f</sub>	)		19		ns
Q <sub>g(on)</sub>	)		90		nC
$\mathbf{Q}_{gs}$	$V_{GS} = 10 \text{ V}, V_{DS} = 0.5 V_{DSS}, I_{D} = 0.5 I_{D25}$		20		nC
$\mathbf{Q}_{\mathrm{gd}}$	J		30		nC
R <sub>thJC</sub>				0.42	K/W
R <sub>thCK</sub>	(TO-247)		0.25		K/W

# TO-247 AD (IXFH) Outline G Dim. Millimeter Inches

Dilli.	14111111	iictci	11101103		
	Min.	Max.	Min.	Max.	
		20.32 21.46		0.800 0.845	
СБ	15.75 3.55	16.26 3.65	0.610 0.140	0.640 0.144	
E F	4.32 5.4	5.49 6.2		0.216 0.244	
G H	1.65	2.13 4.5	0.065	0.084 0.177	
J K	1.0 10.8			0.055 0.433	
L M	4.7 0.4	5.3 0.8	0.185 0.016	0.209 0.031	
N	1.5	2.49	0.087	0.102	

### Source-Drain Diode

Characteristic Values (T. = 25°C, unless otherwise specified)

Symbol	Test Conditions min.	typ.	max.	,
I <sub>s</sub>	V <sub>GS</sub> = 0 V		13	Α
I <sub>SM</sub>	Repetitive;		52	Α
V <sub>SD</sub>	$I_F = I_S$ , $V_{GS} = 0$ V, Pulse test, $t \le 300$ $\mu s$ , duty cycle $d \le 2$ %		1.5	V
t <sub>rr</sub> Q <sub>RM</sub>		0.8 7.5	250	ns μC A

